

ON Semiconductor®

FDS6676AS

30V N-Channel PowerTrench[®] SyncFET[™]

General Description

The FDS6676AS is designed to replace a single SO-8 MOSFET and Schottky diode in synchronous DC:DC power supplies. This 30V MOSFET is designed to maximize power conversion efficiency, providing a low $R_{DS(ON)}$ and low gate charge. The FDS6676AS includes an integrated Schottky diode using ON Semiconductor's monolithic SyncFET technology.

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SO-8

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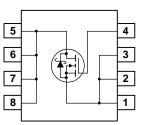
Applications

- DC/DC converter
- Low side notebook



Features

- 14.5 A, 30 V. $R_{DS(ON)} max = 6.0 m\Omega @ V_{GS} = 10 V$ $R_{DS(ON)} max = 7.25 m\Omega @ V_{GS} = 4.5 V$
- Includes SyncFET Schottky body diode
- Low gate charge (45nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$ and fast switching
- High power and current handling capability
- RoHS Compliant



Absolute Maximum Ratings	T _A =25°C unless otherwise noted
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S

S

Symbol	Parameter		Ratings	Unit
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	V
D	Drain Current – Continuous	(Note 1a)	14.5	A
	– Pulsed		50	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
Γ _J , T _{STG}	Operating and Storage Junction Tempera	ature Range	-55 to +150	°C
	Al Characteristics	t (Note 1a)	50	°C/W
North				0/1
R _{eja}	Thermal Resistance, Junction-to-Case	(Note 1)	25	
ج _{یات} Packag	Thermal Resistance, Junction-to-Case e Marking and Ordering Inf Marking Device	, ,	25 Tape width	Quantity

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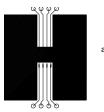
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	1				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, Referenced to 25°C		20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			500	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)	·		•		•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	1	1.5	3	V
ΔV _{GS(th)} ΔTJ	Gate Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to 25°C		-4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			4.5 5.9 6.7	6.0 7.25 8.5	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	50			Α
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_D = 14.5 \text{ A}$		66		S
Dvnamic	Characteristics	·		•		•
Ciss	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		2510		pF
Coss	Output Capacitance	f = 1.0 MHz		710		pF
C _{rss}	Reverse Transfer Capacitance			270		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, f = 1.0 \text{ MHz}$		1.6	2.8	2
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V$, $I_D = 1 A$,		10	20	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		12	22	ns
t _{d(off)}	Turn-Off Delay Time	1		43	69	ns
t _f	Turn-Off Fall Time	1		29	46	ns
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 15 V$, $I_D = 1 A$,		17	31	ns
t _r	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$		22	35	ns
t _{d(off)}	Turn–Off Delay Time			34	54	ns
t _f	Turn–Off Fall Time			29	46	ns
Q _{g(TOT)}	Total Gate Charge at Vgs=10V			45	63	nC
Q _g	Total Gate Charge at Vgs=5V	$V_{DD} = 15 \text{ V}, I_D = 14.5 \text{ A},$		25	35	nC
Q _{gs}	Gate-Source Charge			7		nC
Q_{gd}	Gate–Drain Charge			8		nC

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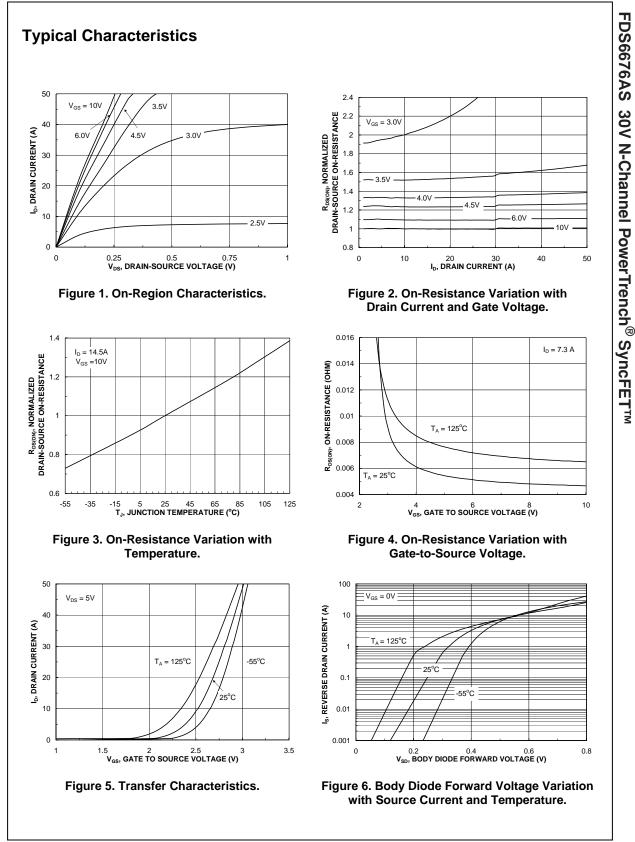
	cal Characteristics	$T_A = 25^{\circ}C$ unless otherwise note	bu				<u> </u>
Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Drain-So	ource Diode Characteristics	and Maximum Rati	ngs				
V _{SD}	Drain–Source Diode Forward Voltage		(Note 2) (Note 2)		0.4 0.5	0.7	V
t _{rr}	Diode Reverse Recovery Time	I _F = 14.5A, d _{iF} /d _t = 300 A/μs			27		nS
I _{RM}	Diode Reverse Recovery Current		(Note 3)		1.9		Α
Q _{rr}	Diode Reverse Recovery Charge	1			26		nC

Notes:

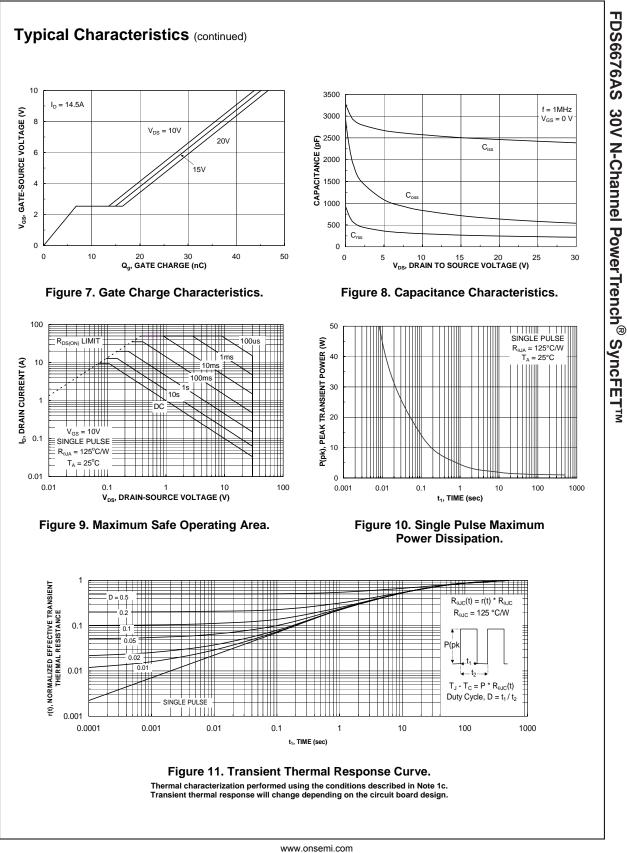
1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 50°/W when mounted on a 1 in² pad of 2 oz copper b) 105°/W when mounted on a .04 in² pad of 2 oz copper www.onsemi.com 3



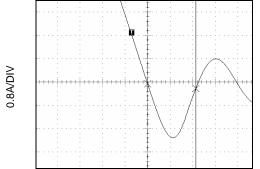
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Typical Characteristics (continued)

SyncFET Schottky Body Diode Characteristics

ON Semiconductor's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 12 shows the reverse recovery characteristic of the FDS6676AS.



10nS/DIV

Figure 12. FDS6676AS SyncFET body diode reverse recovery characteristic.

For comparison purposes, Figure 13 shows the reverse recovery characteristics of the body diode of an equivalent size MOSFET produced without SyncFET (FDS6676).

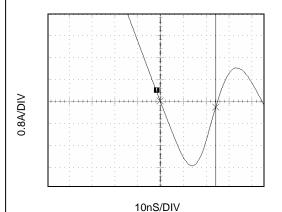


Figure 13. Non-SyncFET (FDS6676) body diode reverse recovery characteristic.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

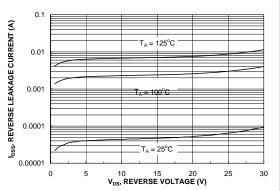
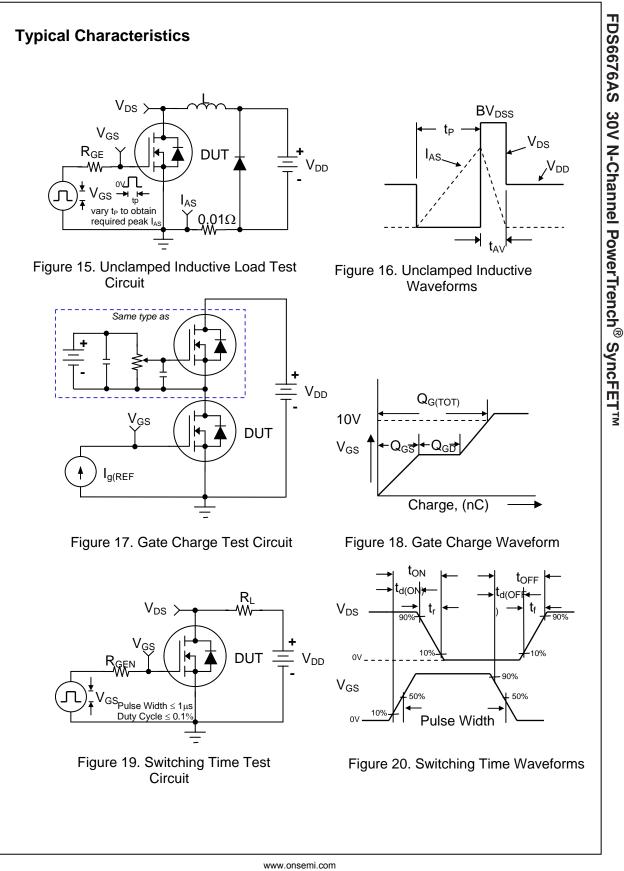


Figure 14. SyncFET body diode reverse leakage versus drain-source voltage and temperature. FDS6676AS 30V N-Channel PowerTrench[®] SyncFET[™]



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